

1. Introduction (简介)

SKI.W6022.1 module is based on ALTOBEAM ATBM6022, complied with IEEE 802.11 b/g/n standard from 2.4GHz ISM band. This documentation describes the engineering requirements specification.

模组 SKI.W6022.1 是基于 ALTOBEAM 的 WIFI 芯片 ATBM6022 开发, 支持 2.4GHz ISM 频段 IEEE 802.11b/g/n 标准。本文档描述了产品的设计要求规范。

2. FEATURES (特性)

Reserving System 接收制式	IEEE Std. 802.11b
	IEEE Std. 802.11g
	IEEE Std. 802.11n
Chip Solution 芯片方案	ATBM6022
Band 波段	2.4G
Dimensions 尺寸	12.3mm*12.7mm*1.5mm

model型号	Installation mode 安装方式	Radio Technology 支持标准	Data rate 数据速率 (MAX)	Operation frequency 频段	Antenna port 天线接口	Remark备注
SKI.W6022.1	SMD	IEEE 802.11b/g/n	150Mbps	2.4 GHz	邮票孔	12.3mm x 12.7mm x 1.5mm

3. Block Diagram (结构框图)

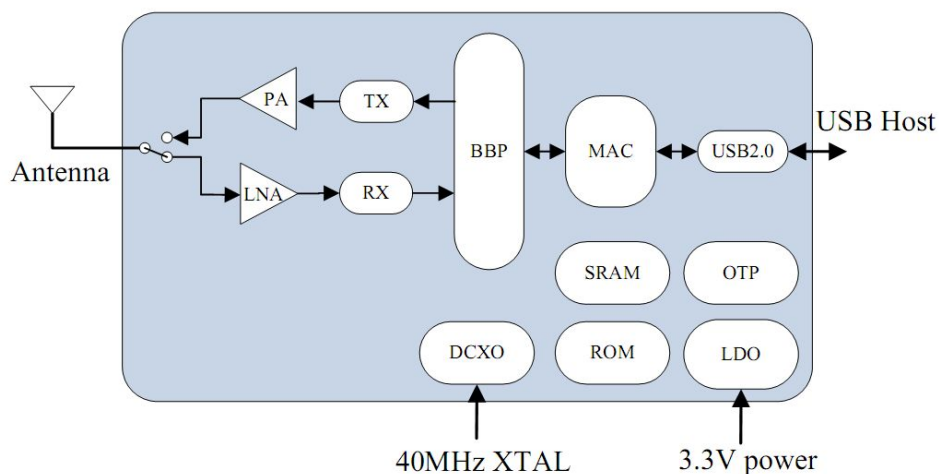
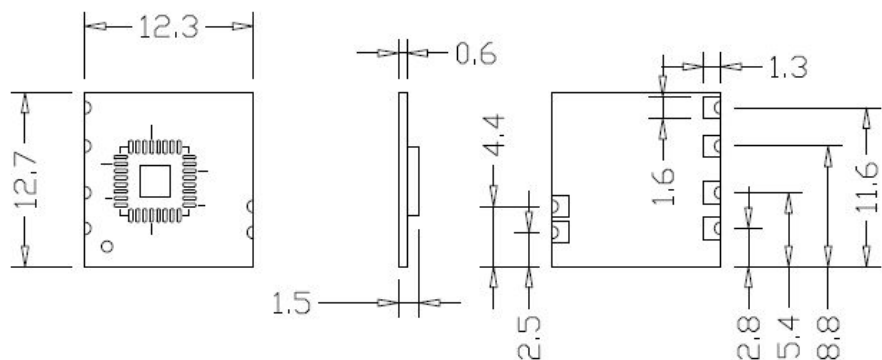


Figure 2.1 SKI.W6022.1 Block Diagram

4. Package Outline and Mounting (外形及安装尺寸)

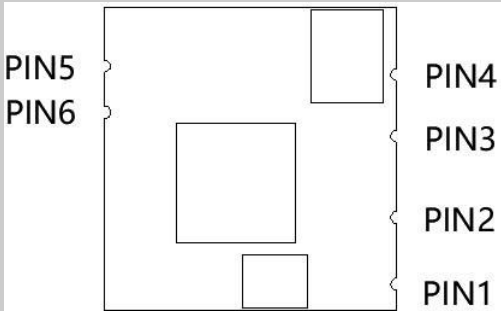


模组主视图 模组侧视图 模组后视图

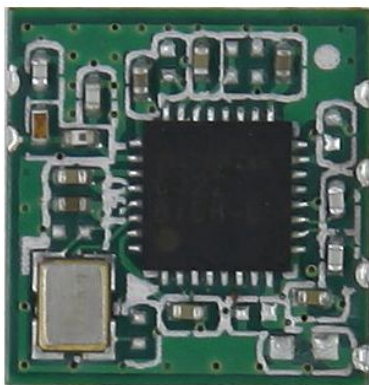
注意：1单位为mm

2模组外形尺寸公差为0.2mm，板厚以及未标注公差为0.1mm

5. Pin Definition (引脚定义)

 <p style="text-align: center;">正视图</p>		
PIN	SYMBOL	DESCRIPTION
1	VCC	3.3V Power Supply
2	DM	USB D-
3	DP	USB D+
4,5	GND	Connected to Ground
6	ANT	RF Signal Throughout

6. Product Pictures (实物图片)



正视图 (top view)



背视图 (bottom view)

丝印说明:

- (1) 红色方框内的字符为产品型号;
- (2) 黄色方框内的字符为产品周期号。

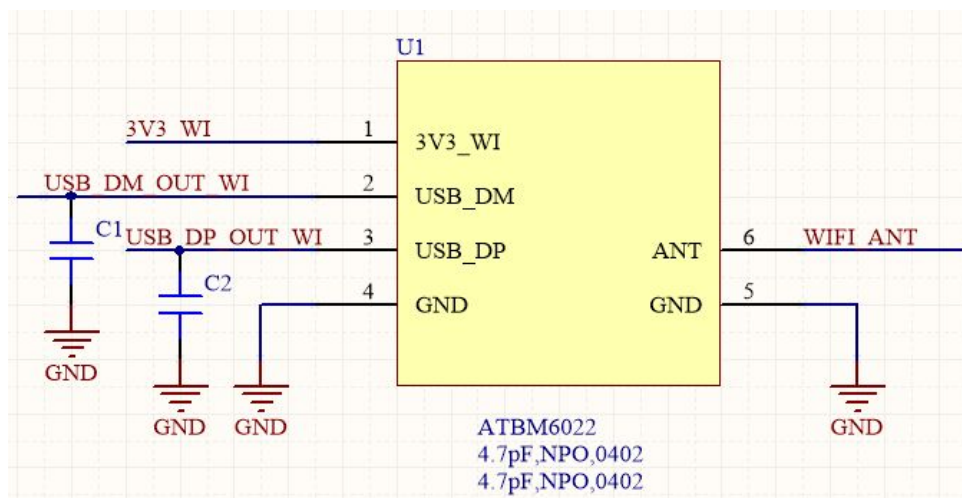
7. Key Materials (关键物料)

序号	关键件名称	型号	规格/材料	生产者	备注
1	集成电路	ATBM6022	32-QFN	ALTOBEAM	
2	PCB	SKI.W6022.1	FR-4,4LAY	福昌发	
3	晶体振荡器	PF4040M00012T2115138	40MHz	晶威特 (JWT)	

8. General Requirements (一般要求)

No.	Feature	Description
8-1	Operation Voltage	3.3V+/-0.3
8-2	Current Consumption	500mA
8-3	Ripple	≤70mV
8-4	Operation Temperature	-10°C to +70°C
8-5	Antenna Type	External antenna
8-6	USB	High Speed USB 2.0 Interface
8-7	Storage Temperature	-40°C to +125°C

说明：建议主板 USB 每条差分线并联一颗 4.7pF 电容（如下图 C1、C2）。



9. Electrical Characteristics (电气特性)

9.1 IEEE 802.11b Section

Items	Contents				
Specification	IEEE802.11b				
Mode	CCK				
Channel	CH1 to CH13				
Data rate	1, 2, 5.5, 11Mbps				
TX Characteristics	Min.	Typ.	Max.	Unit	Remark
1. Power Levels(Calibrated)					
1) For Each antenna port	14.5	16.5	18.5	dBm	
2. Spectrum Mask @ target power					
1) fc +/-11MHz to +/-22MHz	-	-	-30	dBr	
2) fc > +/-22MHz	-	-	-50	dBr	
3 Constellation Error(EVM)@ target power					
1) 1Mbps	-	-	-10	dB	
2) 2Mbps	-	-	-10	dB	
3) 5.5Mbps	-	-	-10	dB	
4) 11Mbps	-	-	-10	dB	
4. Frequency Error	-25	-	25	ppm	
RX Characteristics	Min.	Typ.	Max.	Unit	
5 Minimum Input Level Sensitivity (each chain)					
1) 1Mbps (FER ≤8%)	-	-	-83	dBm	
2) 2Mbps (FER ≤8%)	-	-	-80	dBm	
3) 5.5Mbps (FER ≤8%)	-	-	-79	dBm	
4) 11Mbps (FER ≤8%)	-	-	-76	dBm	
6 Maximum Input Level (FER ≤8%)	-10	-	-	dBm	

9.2 IEEE 802.11g Section

Items	Contents				
Specification	IEEE802.11g				
Mode	OFDM				
Channel	CH1 to CH13				
Data rate	6, 9, 12, 18, 24, 36, 48, 54Mbps				
TX Characteristics	Min.	Typ.	Max.	Unit	Remark
1. Power Levels					
1) For Each antenna port	13	15	17	dBm	
2. Spectrum Mask @ target power					
1) at fc +/-11MHz	-	-	-20	dB	
2) at fc +/-20MHz	-	-	-28	dB	
3) at fc > +/-30MHz	-	-	-40	dB	
3 Constellation Error(EVM)@ target power					
1) 6Mbps	-	-	-5	dB	
2) 9Mbps	-	-	-8	dB	
3) 12Mbps	-	-	-10	dB	
4) 18Mbps	-	-	-13	dB	
5) 24Mbps	-	-	-16	dB	
6) 36Mbps	-	-	-19	dB	
7) 48Mbps	-	-	-22	dB	
8) 54Mbps	-	-	-25	dB	
4 Frequency Error	-25	-	25	ppm	
RX Characteristics	Min.	Typ.	Max.	Unit	
5 Minimum Input Level Sensitivity (each chain)					
1) 6Mbps (PER ≤10%)	-	-	-85	dBm	
2) 9Mbps (PER ≤10%)	-	-	-84	dBm	
3) 12Mbps (PER ≤10%)	-	-	-82	dBm	
4) 18Mbps (PER ≤10%)	-	-	-80	dBm	
5) 24Mbps (PER ≤10%)	-	-	-77	dBm	
6) 36Mbps (PER ≤10%)	-	-	-73	dBm	
7) 48Mbps (PER ≤10%)	-	-	-69	dBm	
8) 54Mbps (PER ≤10%)	-	-	-65	dBm	
6 Maximum Input Level (PER ≤10%)	-20	-	-	dBm	

9.3 IEEE 802.11n HT20 Section

Items	Contents				
Specification	EEE802.11n HT20 @ 2.4GHz				
Mode	OFDM				
Channel	CH1 to CH13				
Data rate (MCS index)	MCS0/1/2/3/4/5/6/7				
TX Characteristics	Min.	Typ.	Max.	Unit	
2. Power Levels					
1) For Each antenna port	12	14	16	dBm	
3. Spectrum Mask @ target power					
1) at fc +/-11MHz	-	-	-20	dB	
2) at fc +/-20MHz	-	-	-28	dB	
3) at fc > +/-30MHz	-	-	-45	dB	
4. Constellation Error(EVM)@ target power					
1) MCS0	-	-	-5	dB	
2) MCS1	-	-	-10	dB	
3) MCS2	-	-	-13	dB	
4) MCS3	-	-	-16	dB	
5) MCS4	-	-	-19	dB	
6) MCS5	-	-	-22	dB	
7) MCS6	-	-	-25	dB	
8) MCS7	-	-	-28	dB	
5. Frequency Error	-25	-	25	ppm	
RX Characteristics	Min.	Typ.	Max.	Unit	
6. Minimum Input Level Sensitivity (each chain)					
1) MCS0 (PER ≤10%)	-	-	-82	dBm	
2) MCS1 (PER ≤10%)	-	-	-79	dBm	
3) MCS2 (PER ≤10%)	-	-	-77	dBm	
4) MCS3 (PER ≤10%)	-	-	-74	dBm	
5) MCS4 (PER ≤10%)	-	-	-70	dBm	
6) MCS5 (PER ≤10%)	-	-	-66	dBm	
7) MCS6 (PER ≤10%)	-	-	-65	dBm	
8) MCS7 (PER ≤10%)	-	-	-64	dBm	
7. Maximum Input Level (PER ≤10%)	-20	-	-	dBm	

9.4 IEEE 802.11n HT40 Section

Items	Contents				
Specification	IEEE802.11n HT40 @ 2.4GHz				
Mode	OFDM				
Channel	CH3 to CH11				
Data rate (MCS index)	MCS0/1/2/3/4/5/6/7				
	Min.	Typ.	Max.	Unit	Remark
TX Characteristics	Min.	Typ.	Max.	Unit	
1. Power Levels (Calibrated)					
1) For Each antenna port	11	13	15	dBm	
2. Spectrum Mask @target power					
1) at fc +/-22MHz	-	-	-20	dB	
2) at fc +/-40MHz	-	-	-28	dB	
3) at fc > +/-60MHz	-	-	-45	dB	
3. Constellation Error(EVM)@ target power					
1) MCS0	-	-	-5	dB	
2) MCS1	-	-	-10	dB	
3) MCS2	-	-	-13	dB	
4) MCS3	-	-	-16	dB	
5) MCS4	-	-	-19	dB	
6) MCS5	-	-	-22	dB	
7) MCS6	-	-	-25	dB	
8) MCS7	-	-	-28	dB	
4. Frequency Error	-25	-	25	ppm	
RX Characteristics	Min.	Typ.	Max.	Unit	
5. Minimum Input Level Sensitivity (each chain)					
1) MCS0 (PER \leq 10%)	-	-	-79	dBm	
2) MCS1 (PER \leq 10%)	-	-	-76	dBm	
3) MCS2 (PER \leq 10%)	-	-	-74	dBm	
4) MCS3 (PER \leq 10%)	-	-	-71	dBm	
5) MCS4 (PER \leq 10%)	-	-	-67	dBm	
6) MCS5 (PER \leq 10%)	-	-	-63	dBm	
7) MCS6 (PER \leq 10%)	-	-	-62	dBm	
8) MCS7 (PER \leq 10%)	-	-	-61	dBm	
6. Maximum Input Level (PER \leq10%)	-20	-	-	dBm	

10. Mechanical, Environmental and Reliability Tests

(机械、环境和可靠性测试)

Test Items		Test Conditions	Qty	Criteria Condition
4-1	Drop test	The packed samples within 100Kg can be tested Drop height: Face Side: 800/600/450mm Edge line: 600/450/350mm Drop time: 1 each Face and edge.	1xBox	After drop test, the outer box and inner box will not be broken by appearance visual inspection.
4-2	Vibration test	X-Y-Z direction, first Frequency changing from 10Hz to 30Hz to 10Hz, amplitude 0.75mm, 5 times vibrations, then frequency Changing from 30Hz to 55 Hz to 30 Hz, amplitude 0.15mm, 5 time vibration.	3	After test, the Appearance, Power EVM and Frequency error shall be satisfied with the specification.
4-3	Impact test	Impact acceleration: 50m/sec ² ; Impact duration: 16ms; Impact times: 1000.	3	After test, the Appearance, Power EVM and Frequency error shall be satisfied with the specification.
4-4	Soldering ability test	Soldering temperature: 235±5℃ Soldering duration: 2±0.5S	3	1.After soldering, the soldered area must be covered by a smooth bright solder layer, some deficiencies such as a small amount of the pinhole, not wetting are allowed, but the deficiencies can not be in the same place; 2.At least 90% of soldered area shall be covered continuously by the soldering material.
4-5	Humidity test	Leave samples in 40±3℃, 93% RH @ 96 hours	3	Leave samples in standard test condition for 2 hours then test, the Appearance, Power, EVM and Frequency error functional parameter shall be satisfied with the test specification.

4-6	High temperature load life test	Thermostat cabinet temperature: 55±5℃ Applied voltage: 110% rated voltage Working duration: 200 hour (Supply Voltage Cycle 23h power on, 1h power off)	60	After test, leave samples in standard condition for 1 hour and test, Power, EVM and Frequency error shall be satisfied with the test specification.
4-7	High temperature load test	Temperature: 55±5℃ Samples work for 16 hours	3	After test, the Appearance, Power, EVM and Frequency error shall be Satisfied with the test specification.
4-8	Low temperature storage test	Leave the samples in -25±3℃@24 hours	3	Leave samples in standard test condition for 2 hours then test, the Appearance, Power, EVM and Frequency error shall be satisfied with the test specification.
4-9	Low temperature load test	Leave samples in -15±3℃@ 2 hours, samples' function shall be normal, the let samples work for 1 hour	3	After test, leave the samples in standard condition and tested the Appearance, Power, EVM and Frequency error shall be satisfied with the test specification.
4-10	Temperature circle test	One cycle duration -10±3℃@3H 40±3℃ @3H Total cycle: 10x	3	After test, leave the samples in standard condition and tested Power EVM and Frequency error shall be qualified and all the characters shall be satisfied with the test specification.
4-11	Continuous TP test	Twice cycle duration -10±3℃@4H +60±3℃@4H, +25@2H@2H	3	During test, There will not been appeared signal disconnection or interruption between DUT and AP.
4-12	ESD	Discharge voltage: 1kV C: 150pF Discharge resistance: 330Ω Positive10 times 1 time for each second	3	The products can recoverable smoothly after ESD test.

Federal Communication Commission Interference Statement

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Caution:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

The module must be professionally.

IMPORTANT NOTE:

In the event that these conditions can not be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End Product Labeling

The final end product must be labeled in a visible area with the following:
"Contains FCC ID:2AR82-SKIW6022101".

Manual Information to the End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module.